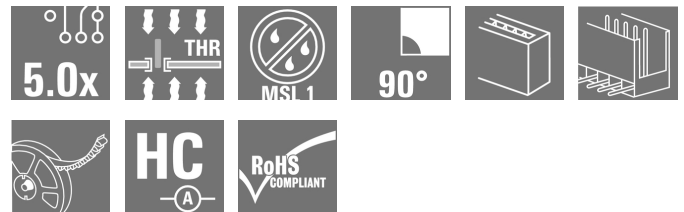


**OMNIMATE Signal - series BL/SL 5.08
SL-SMART 5.0XHC/03/90 1.5SN BK RL**

Weidmüller Interface GmbH & Co. KG
Klingenbergstraße 26
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High-temperature resistant, modular pin header. Packed in tape with 1.5mm solder pin, optimised for automatic assembly and suitable for reflow soldering. The male connectors provide space for labelling and can be coded. HC = High Current.

General ordering data

| | |
|--------------|--|
| Type | SL-SMART 5.0XHC/03/90 1.5SN BK RL |
| Order No. | 1812440000 |
| Version | PCB plug-in connector, male header, open side, THT/THR solder connection, 5.00 mm, Number of poles: 3, 90°, Solder pin length (l): 1.5 mm, tinned, black, Tape |
| GTIN (EAN) | 4032248294022 |
| Qty. | 350 pc(s). |
| Product data | IEC: 400 V / 27.5 A UL: 300 V / 15 A |
| Packaging | Tape |

Creation date April 4, 2020 7:10:32 AM CEST

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Technical data**Dimensions and weights**

| | | | |
|--------------------------|------------|-----------------|------------|
| Width | 15 mm | Width (inches) | 0.591 inch |
| Height | 9.8 mm | Height (inches) | 0.386 inch |
| Height of lowest version | 8.3 mm | Depth | 12 mm |
| Depth (inches) | 0.472 inch | Net weight | 2.151 g |

System specifications

| | | | |
|----------------------------------|-------------------------------------|---|-----------------------|
| Product family | OMNIMATE Signal - series BL/SL 5.08 | Type of connection | Board connection |
| Mounting onto the PCB | THT/THR solder connection | Pitch in mm (P) | 5 mm |
| Pitch in inches (P) | 0.197 inch | Outgoing elbow | 90° |
| Number of poles | 3 | Number of solder pins per pole | 1 |
| Solder pin length (l) | 1.5 mm | Solder pin length tolerance | 0 / -0.3 mm |
| Tolerance of solder pin position | ± 0.1 mm | Solder pin dimensions | d = 1.2 mm, Octagonal |
| Solder eyelet hole diameter (D) | 1.4 mm | Solder eyelet hole diameter tolerance (D) | + 0,1 mm |
| L1 in mm | 10 mm | L1 in inches | 0.394 inch |
| Number of rows | 1 | Pin series quantity | 1 |
| Volume resistance | ≤ 5mΩ | Can be coded | Yes |
| Plugging cycles | 25 | Plugging force/pole, max. | 8.5 N |
| Pulling force/pole, max. | 8 N | | |

Material data

| | | | |
|---------------------------------------|----------------------------|---------------------------------------|----------------------------|
| Insulating material | LCP GF | Colour | black |
| Colour chart (similar) | RAL 9011 | Insulating material group | IIIa |
| Comparative Tracking Index (CTI) | ≥ 175 | Insulation strength | ≥ 10 ⁸ Ω |
| Moisture Level (MSL) | 1 | UL 94 flammability rating | V-0 |
| GWIT | 930 °C | GWFI | 960 °C |
| Contact material | CuMg | Contact surface | tinned |
| Layer structure of solder connection | 1-3 μm Ni / 2-4 μm Sn matt | Layer structure of plug contact | 1-3 μm Ni / 2-4 μm Sn matt |
| Storage temperature, min. | -25 °C | Storage temperature, max. | 50 °C |
| Max. relative humidity during storage | 70 % | Operating temperature, min. | -50 °C |
| Operating temperature, max. | 100 °C | Temperature range, installation, min. | -30 °C |
| Temperature range, installation, max. | 100 °C | | |


Rated data acc. to IEC

| | | | |
|---|------------------------|---|--------|
| tested acc. to standard | IEC 60664-1, IEC 61984 | Rated current, min. number of poles (Tu=20°C) | 27.5 A |
| Rated current, max. number of poles (Tu=20°C) | 19 A | Rated current, min. number of poles (Tu=40°C) | 24 A |
| Rated current, max. number of poles (Tu=40°C) | 16.5 A | Rated voltage for surge voltage class / pollution degree II/2 | 400 V |
| Rated voltage for surge voltage class / pollution degree III/2 | 320 V | Rated voltage for surge voltage class / pollution degree III/3 | 250 V |
| Rated impulse voltage for surge voltage class/ pollution degree II/2 | 4 kV | Rated impulse voltage for surge voltage class/ pollution degree III/2 | 4 kV |
| Rated impulse voltage for surge voltage class/ contamination degree III/3 | 4 kV | | |

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Technical data
Rated data acc. to CSA

| | | | |
|-----------------------------------|---|-----------------------------------|----------------|
| Institute (CSA) |  | Certificate No. (CSA) | 154685-1176845 |
| Rated voltage (Use group B / CSA) | 300 V | Rated voltage (Use group D / CSA) | 300 V |
| Rated current (Use group B / CSA) | 15 A | Rated current (Use group D / CSA) | 15 A |
| Reference to approval values | Specifications are maximum values, details - see approval certificate. | | |

Rated data acc. to UL 1059

| | | | |
|---------------------------------------|---|---------------------------------------|--------|
| Institute (UR) |  | Certificate No. (UR) | E60693 |
| Rated voltage (Use group B / UL 1059) | 300 V | Rated voltage (Use group D / UL 1059) | 300 V |
| Rated current (Use group B / UL 1059) | 15 A | Rated current (Use group D / UL 1059) | 10 A |
| Reference to approval values | Specifications are maximum values, details - see approval certificate. | | |

Packing

| | | | |
|--------------------------------------|----------|-----------------------------|-------------------------------|
| Packaging | Tape | VPE length | 40 mm |
| VPE width | 320 mm | VPE height | 320 mm |
| Tape depth (T2) | 12.8 mm | Tape width (W) | 32 mm |
| Tape pocket depth (K0) | 12.3 mm | Tape pocket height (A0) | 12.3 mm |
| Tape pocket width (B0) | 15.34 mm | Tape pocket separation (P1) | 16 mm |
| Tape hole separation (E) | 1.75 mm | Tape pocket separation (F) | 14.2 mm |
| Tape reel diameter \varnothing (A) | 330 mm | Surface resistance | $R_s = 10^9 - 10^{12} \Omega$ |

Classifications

| | | | |
|-------------|-------------|------------|-------------|
| ETIM 6.0 | EC002637 | ETIM 7.0 | EC002637 |
| eClass 9.0 | 27-44-04-02 | eClass 9.1 | 27-44-04-02 |
| eClass 10.0 | 27-44-04-02 | UNSPSC | 30-21-18-10 |

Notes

| | |
|----------------|---|
| Notes | <ul style="list-style-type: none"> • Gold-plated contact surfaces on request • Rated current related to rated cross-section & min. No. of poles. • P on drawing = pitch • Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards. |
| IPC conformity | Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request. |

Data sheet

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Technical data

Approvals

Approvals



ROHS

Conform

Downloads

Approval/Certificate/Document of Conformity

[Declaration of the Manufacturer](#)

Brochure/Catalogue

- [FL DRIVES EN](#)
- [MB DEVICE MANUF. EN](#)
- [FL DRIVES DE](#)
- [CAT 2 PORTFOLIOGUIDE EN](#)
- [FL BUILDING SAFETY EN](#)
- [FL APPL LED LIGHTING EN](#)
- [FLIndustr.CONTROLS EN](#)
- [FL MACHINE SAFETY EN](#)
- [FL HEATING ELECTR EN](#)
- [FL APPL INVERTER EN](#)
- [FL_BASE_STATION_EN](#)
- [FL ELEVATOR EN](#)
- [FL POWER SUPPLY EN](#)
- [FL 72H SAMPLE SER EN](#)
- [PO OMNIMATE EN](#)

Engineering Data

[SL-SMART.zip](#)
[STEP](#)

White paper surface mount technology

[Download Whitepaper](#)

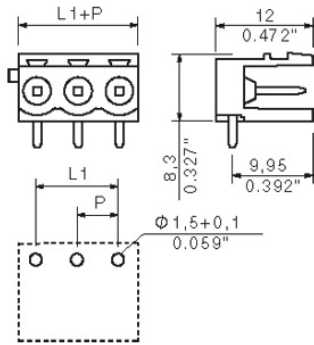
Data sheet

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Drawings

Dimensional drawing



Example of use



Safe power transmission

Product benefits Proven properties

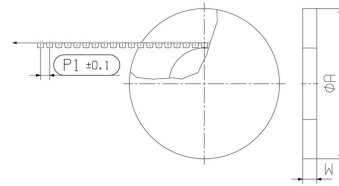


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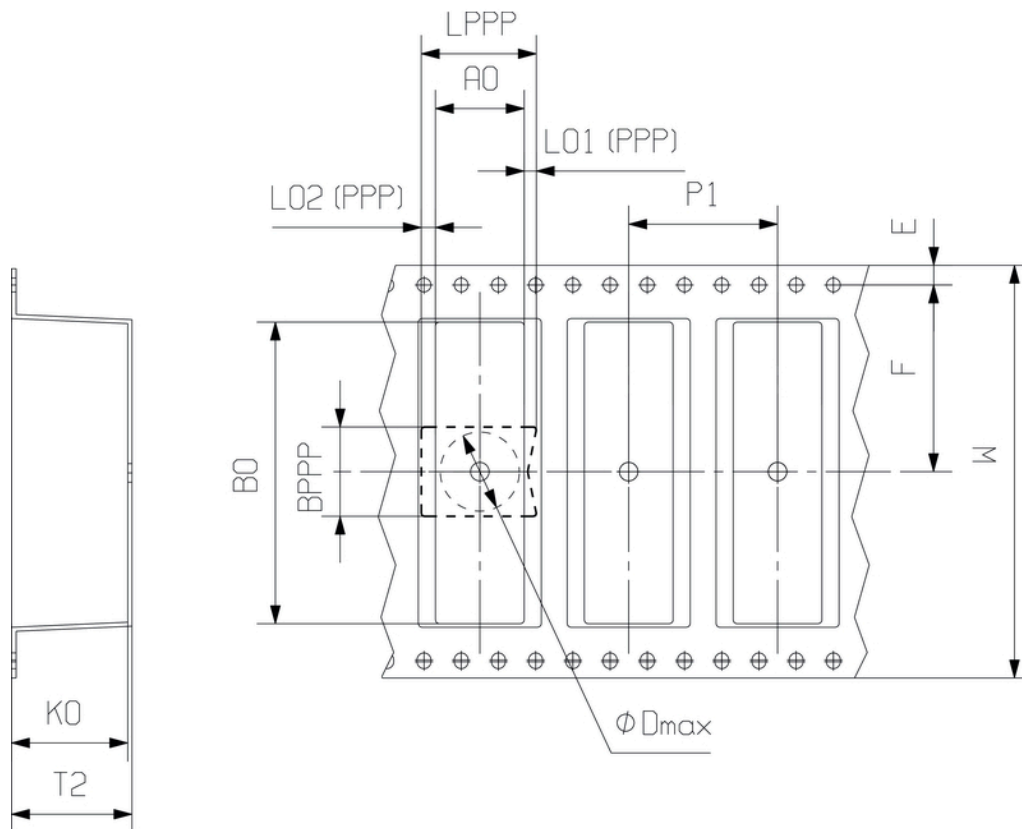
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Drawings

Dimensional drawing



Dimensional drawing



Recommended wave soldering profiles

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Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:

- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

Recommended reflow soldering profile

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Reflow soldering profile

The perfect soldering profile for SMT Surface Mount Technology is one the most exiting question in SMT production. But there are more than one correct answer: The diagram of temperature-on-time is related to processing features of solder paste and to maximum load of components.

We have to consider the following parameters:

- Time for pre heating
- Maximum temperature
- Time above melting point
- Time for cooling
- Maximum heating rate
- Maximum cooling rate

We recommend a typical solder profile with associated process limits. With preheating components and board are prepared smoothly for the solder phase. Heating rate is typically $\leq +3\text{K/s}$. In parallel the solder paste is ‚activated‘. The time above melting point of 217°C the paste gets liquid and components and boards begin to connect. The maximum temperature of 245°C to 254°C should stay between 10 and 40 seconds. In the cooling phase at $\geq -6\text{K/s}$ solder is cured. Board and components cool down while avoiding cold cracks.